



NCE N-Channel Enhancement Mode Power MOSFET

DESCRIPTION (2) D The NCE80H12 uses advanced trench technology and design to provide excellent R_{DS(ON)} with low gate charge. It can be used in a wide variety of applications. (1) G 아 **GENERAL FEATURES** (3) s V_{DS} =80V,I_D =120A $R_{DS(ON)}$ <6m Ω @ V_{GS}=10V Schematic diagram High density cell design for ultra low Rdson • Fully characterized Avalanche voltage and current Good stability and uniformity with high E_{AS} • Excellent package for good heat dissipation NCE Special process technology for high ESD capability NCE80H12 WW YY Application G DS Power switching application Hard Switched and High Frequency Circuits Marking and pin Assignment • Uninterruptible Power Supply 100% UIS TESTED! 100% ΔVds TESTED!

Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE80H12	NCE80H12	TO-220	-	-	-

TO-220 top view

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	80	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I _D	120	A
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	84	A
Pulsed Drain Current	I _{DM}	450	A
Maximum Power Dissipation	PD	220	W
Derating factor		1.47	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	1400	mJ
Operating Junction and Storage Temperature Range	TJ,TSTG	-55 To 175	°C





Thermal Characteristic

Thermal Resistance, Junction-to-Case(Note 2)	$R_{ extsf{ heta}JC}$	0.68	°C /W
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Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	80	89	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =80V,V _{GS} =0V		-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·					
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =40A	-	4.9	6	mΩ
Forward Transconductance	g fs	V _{DS} =25V,I _D =57A	90	-	-	S
Dynamic Characteristics (Note4)	·					
Input Capacitance	C _{lss}		-	6500	-	PF
Output Capacitance	Coss	V _{DS} =25V,V _{GS} =0V, F=1.0MHz	-	520	-	PF
Reverse Transfer Capacitance	C _{rss}		-	460	-	PF
Switching Characteristics (Note 4)	·					
Turn-on Delay Time	t _{d(on)}		-	26	-	nS
Turn-on Rise Time	tr	V_{DD} =30V, I_D =2A, R_L =15 Ω	-	24	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =2.5Ω	-	91	-	nS
Turn-Off Fall Time	t _f		-	39	-	nS
Total Gate Charge	Qg)/ _20)/ _20)	-	163		nC
Gate-Source Charge	Q _{gs}	V _{DS} =30V,I _D =30A, V _{GS} =10V	-	31		nC
Gate-Drain Charge	Q _{gd}	VGS-10V	-	64		nC
Drain-Source Diode Characteristics	·					
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =40A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	120	А
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 40A	-	42	60	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs(Note3) - 66 80		nC		
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

5. EAS condition: Tj=25 $^\circ \!\! \mathrm{C}$,V_DD=40V,V_G=10V,L=0.5mH,Rg=25 Ω



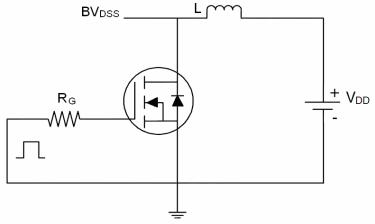
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Pb Free Product

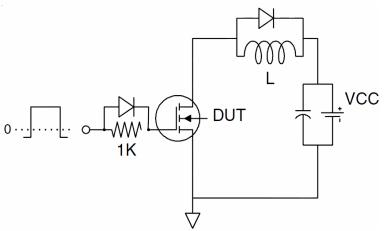


Test circuit

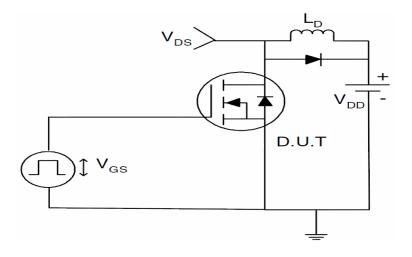
1) E_{AS} test Circuits



2) Gate charge test Circuit:



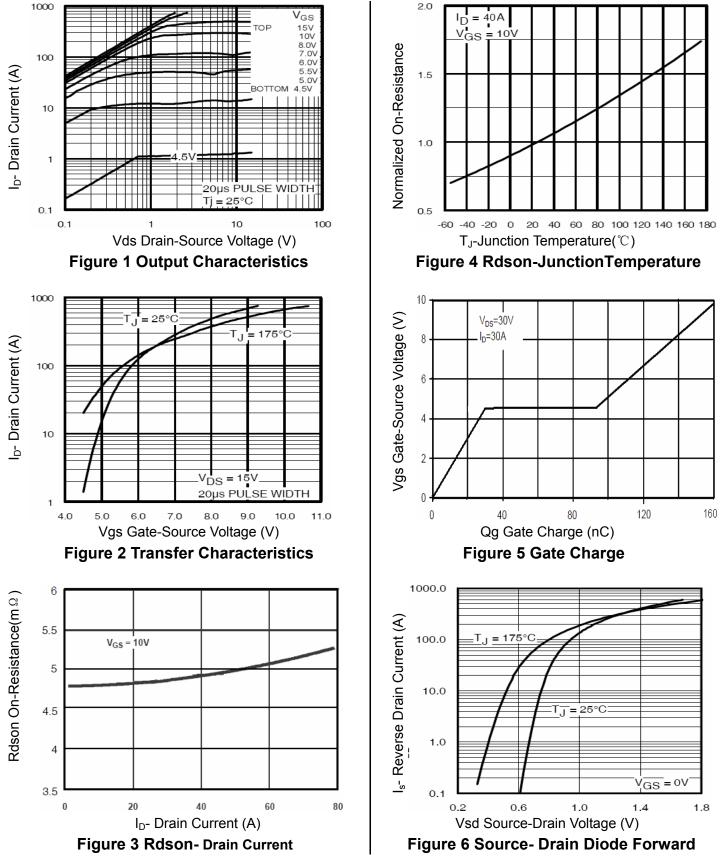
3) Switch Time Test Circuit:





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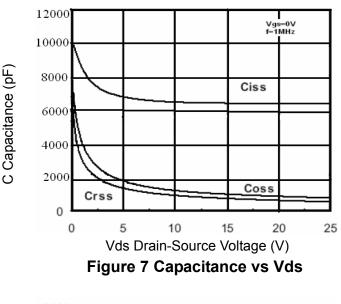
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)

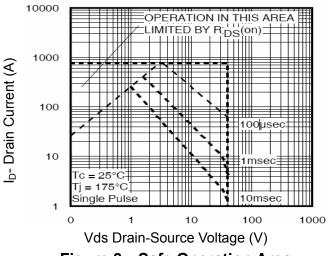


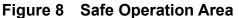












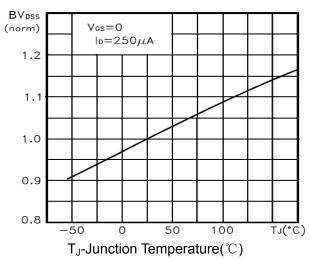


Figure 9 BV_{DSS} vs Junction Temperature

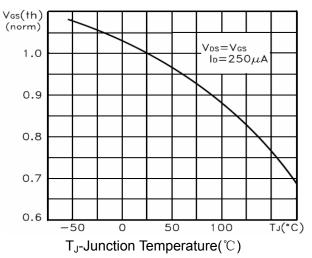
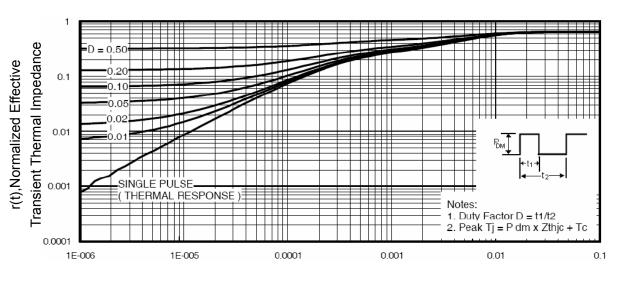
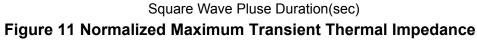


Figure 10 V_{GS(th)} vs Junction Temperature



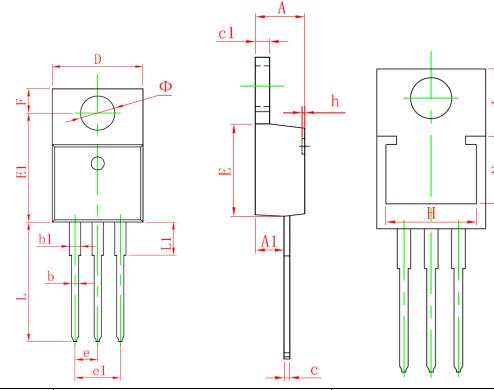






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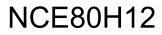
TO-220-3L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	4.470	4.670	0.176	0.184	
A1	2.520	2.820	0.099	0.111	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
c	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	10.010	10.350	0.394	0.407	
Ε	8.500	8.900	0.335	0.350	
E1	12.060	12.460	0.475	0.491	
e	2.540 (TYP.)		0.100 (TYP.)		
e1	4.980	5.180	0.196	0.204	
F	2.590	2.890	0.102	0.114	
Н	8.440 REF.		0.332 REF.		
h	0.000	0.300	0.000	0.012	
L	13.400	13.800	0.528	0.543	
L1	3.560	3.960	0.140	0.156	
V	6.360 REF.		0.250 REF.		
Ι	6.300 REF.		0.248 REF.		
Φ	3.735	3.935	0.147	0.155	



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